# Dual 40 V, 6.0 A, Low **V<sub>CE(sat)</sub> PNP** Transistor

ON Semiconductor's e<sup>2</sup>PowerEdge family of low V<sub>CE(sat)</sub> transistors are surface mount devices featuring ultra low saturation voltage (V<sub>CE(sat)</sub>) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e<sup>2</sup>PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

#### **Features**

- Halide Free
- This is a Pb-Free Device

#### MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Rating	Symbol	Мах	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	-40	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	-40	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	-7.0	Vdc
Collector Current – Continuous	Ι <sub>C</sub>	-3.0	А
Collector Current – Peak	I <sub>CM</sub>	-6.0	А
Electrostatic Discharge	ESD	HBM Class 3B MM Class C	

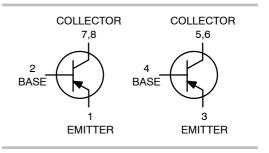
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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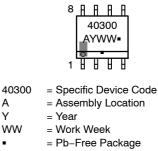
# 40 VOLTS **6.0 AMPS** PNP LOW V<sub>CE(sat)</sub> TRANSISTOR EQUIVALENT R<sub>DS(on)</sub> 80 mΩ





STYLE 16





А

Y

WW

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NSS40300DDR2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
SINGLE HEATED			
Total Device Dissipation (Note 1) $T_A = 25^{\circ}C$	PD	576	mW
Derate above 25°C		4.6	mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{ heta JA}$	217	°C/W
Total Device Dissipation (Note 2) $T_A = 25^{\circ}C$	PD	676	mW
Derate above 25°C		5.4	mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	R <sub>θJA</sub>	185	°C/W
DUAL HEATED (Note 3)		· ·	
Total Device Dissipation (Note 1) $T_{A} = 25^{\circ}C$	PD	653	mW
Derate above 25°C		5.2	mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{ ext{ heta}JA}$	191	°C/W
Total Device Dissipation (Note 2) $T_{A} = 25^{\circ}C$	PD	783	mW
Derate above 25°C		6.3	mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	160	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

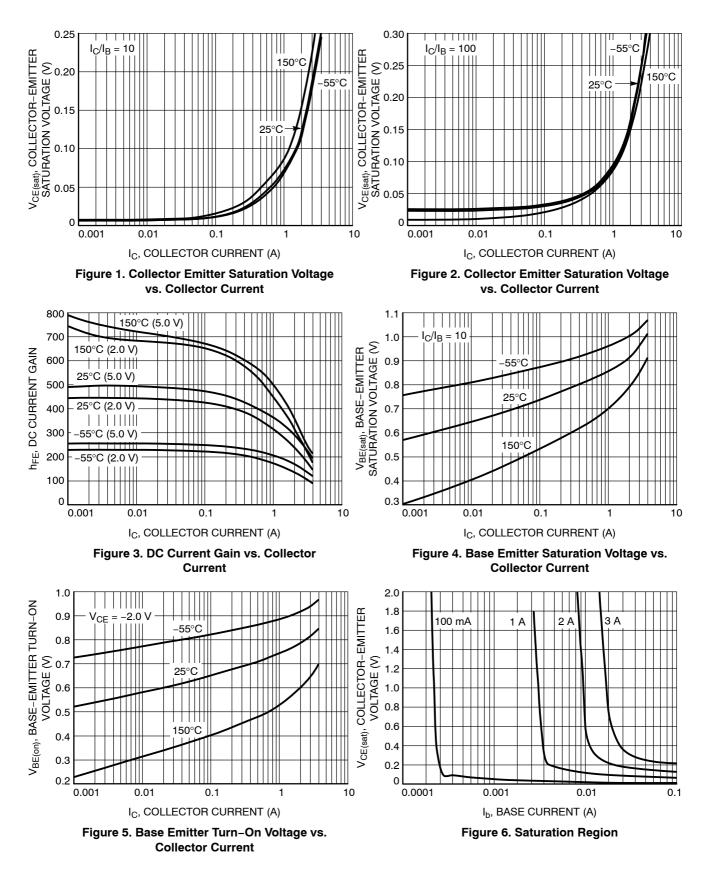
FR-4 @ 10 mm<sup>2</sup>, 1 oz. copper traces, still air.
FR-4 @ 100 mm<sup>2</sup>, 1 oz. copper traces, still air.
Dual heated values assume total power is the sum of two equally powered devices.

#### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•				
Collector – Emitter Breakdown Voltage $(I_{C} = -10 \text{ mAdc}, I_{B} = 0)$	V <sub>(BR)CEO</sub>	-40	_	_	Vdc
Collector – Base Breakdown Voltage $(I_{C} = -0.1 \text{ mAdc}, I_{E} = 0)$	V <sub>(BR)CBO</sub>	-40	_	_	Vdc
Emitter – Base Breakdown Voltage $(I_E = -0.1 \text{ mAdc}, I_C = 0)$	V <sub>(BR)EBO</sub>	-7.0	-	_	Vdc
Collector Cutoff Current ( $V_{CB} = -40$ Vdc, $I_E = 0$ )	I <sub>СВО</sub>	_	-	-0.1	μAdc
Emitter Cutoff Current (V <sub>EB</sub> = -6.0 Vdc)	I <sub>EBO</sub>	_	-	-0.1	μAdc
ON CHARACTERISTICS					
DC Current Gain (Note 4) ( $I_C = -10 \text{ mA}, V_{CE} = -2.0 \text{ V}$ ) ( $I_C = -500 \text{ mA}, V_{CE} = -2.0 \text{ V}$ ) ( $I_C = -1.0 \text{ A}, V_{CE} = -2.0 \text{ V}$ ) ( $I_C = -2.0 \text{ A}, V_{CE} = -2.0 \text{ V}$ )	h <sub>FE</sub>	250 220 180 150	380 340 300 230	- - -	
Collector – Emitter Saturation Voltage (Note 4) ( $I_C = -0.1 \text{ A}, I_B = -0.010 \text{ A}$ ) ( $I_C = -1.0 \text{ A}, I_B = -0.100 \text{ A}$ ) ( $I_C = -1.0 \text{ A}, I_B = -0.010 \text{ A}$ ) ( $I_C = -2.0 \text{ A}, I_B = -0.200 \text{ A}$ )	V <sub>CE(sat)</sub>	- - - -	-0.013 -0.075 -0.130 -0.135	-0.017 -0.095 -0.170 -0.170	V
Base – Emitter Saturation Voltage (Note 4) $(I_C = -1.0 \text{ A}, I_B = -0.01 \text{ A})$	V <sub>BE(sat)</sub>	_	-0.780	-0.900	V
Base – Emitter Turn–on Voltage (Note 4) ( $I_C = -0.1 \text{ A}, V_{CE} = -2.0 \text{ V}$ )	V <sub>BE(on)</sub>	_	-0.660	-0.750	V
Cutoff Frequency (I <sub>C</sub> = $-100$ mA, V <sub>CE</sub> = $-5.0$ V, f = 100 MHz)	f <sub>T</sub>	100	-	_	MHz
Input Capacitance ( $V_{EB} = -0.5 \text{ V}$ , f = 1.0 MHz)	Cibo	-	250	300	pF
Output Capacitance ( $V_{CB} = -3.0 \text{ V}$ , f = 1.0 MHz)	Cobo	-	50	65	pF
SWITCHING CHARACTERISTICS					
Delay (V <sub>CC</sub> = $-30$ V, I <sub>C</sub> = $-750$ mA, I <sub>B1</sub> = $-15$ mA)	t <sub>d</sub>	-	-	60	ns
Rise (V <sub>CC</sub> = $-30$ V, I <sub>C</sub> = $-750$ mA, I <sub>B1</sub> = $-15$ mA)	tr	-	-	120	ns
Storage (V <sub>CC</sub> = $-30$ V, I <sub>C</sub> = $-750$ mA, I <sub>B1</sub> = $-15$ mA)	t <sub>s</sub>	-	-	400	ns
Fall (V <sub>CC</sub> = -30 V, I <sub>C</sub> = -750 mA, I <sub>B1</sub> = -15 mA)	t <sub>f</sub>	-	-	130	ns

4. Pulsed Condition: Pulse Width = 300  $\mu$ sec, Duty Cycle  $\leq$  2%.

#### **TYPICAL CHARACTERISTICS**



## **TYPICAL CHARACTERISTICS**

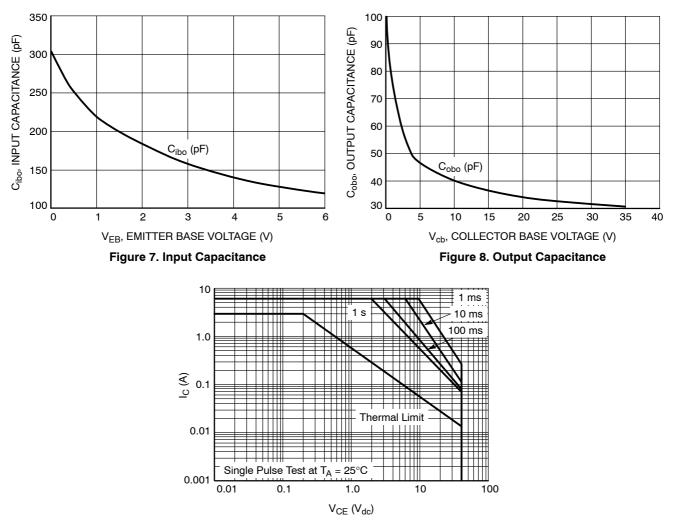


Figure 9. Safe Operating Area





\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### STYLES ON PAGE 2

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#### SOIC-8 NB CASE 751-07 ISSUE AK

STYLE 1: PIN 1. EMITTER COLLECTOR 2. COLLECTOR 3. 4. EMITTER EMITTER 5. BASE 6. 7 BASE EMITTER 8. STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN DRAIN 4. GATE 5. 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6 BASE. DIE #2 BASE, DIE #1 7. 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3 GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. DRAIN 8. STYLE 17: PIN 1. VCC 2. V2OUT V10UT З. TXE 4. 5. RXE 6. VFF 7. GND 8. ACC STYLE 21: CATHODE 1 PIN 1. 2. CATHODE 2 3 CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. 8. CATHODE 6 STYLE 25: PIN 1. VIN 2 N/C REXT 3. 4. GND 5. IOUT 6. IOUT IOUT 7. 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. 2 EMITTER, #1 BASE, #2 З. EMITTER, #2 4. 5 COLLECTOR, #2 COLLECTOR, #2 6.

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 3. 4 COLLECTOR, #2 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: PIN 1. GROUND BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND 6 BIAS 2 INPUT 7. 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE P-SOURCE 3 P-GATE 4. P-DRAIN 5 6. P-DRAIN N-DRAIN 7. N-DRAIN 8. STYLE 18: PIN 1. ANODE 2. ANODE SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. CATHODE 8. STYLE 22 PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC COMMON CATHODE/VCC 3 4. I/O LINE 3 5. COMMON ANODE/GND 6. I/O LINE 4 7. I/O LINE 5 COMMON ANODE/GND 8. STYLE 26: PIN 1. GND 2 dv/dt З. ENABLE 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8. VCC STYLE 30: DRAIN 1 PIN 1. DRAIN 1 2 GATE 2 З. SOURCE 2 4. SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5. 6.

STYLE 3: PIN 1. DRAIN, DIE #1 DRAIN, #1 2. DRAIN, #2 З. 4. DRAIN, #2 GATE, #2 5. SOURCE, #2 6. 7 GATE #1 8. SOURCE, #1 STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS THIRD STAGE SOURCE GROUND З. 4. 5. DRAIN 6. GATE 3 SECOND STAGE Vd 7. FIRST STAGE Vd 8. STYLE 11: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. DRAIN 2 DRAIN 1 7. 8. DRAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 ANODE 1 3 ANODE 1 4. 5. CATHODE, COMMON CATHODE, COMMON CATHODE, COMMON 6. 7. CATHODE, COMMON 8. STYLE 19: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. MIRROR 2 DRAIN 1 7. 8. **MIRROR 1** STYLE 23: PIN 1. LINE 1 IN COMMON ANODE/GND COMMON ANODE/GND 2. 3 LINE 2 IN 4. LINE 2 OUT 5. COMMON ANODE/GND COMMON ANODE/GND 6. 7. LINE 1 OUT 8. STYLE 27: PIN 1. ILIMIT 2 OVI 0 UVLO З. 4. INPUT+ 5. SOURCE SOURCE 6. SOURCE 7. 8 DRAIN

#### DATE 16 FEB 2011

STYLE 4: ANODE ANODE PIN 1. 2. ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 BASE #2 3. COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE SOURCE 2. 3. 4. GATE 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 16: PIN 1. EMITTER, DIE #1 2. BASE, DIE #1 EMITTER, DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE 2. EMITTER 3 COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE 6. CATHODE COLLECTOR/ANODE 7. 8. COLLECTOR/ANODE STYLE 28: PIN 1. SW\_TO\_GND 2. DASIC OFF DASIC\_SW\_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK 8 VIN

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SOURCE 1/DRAIN 2

7.

8. GATE 1

7.

8

rights of others

COLLECTOR, #1

COLLECTOR, #1

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